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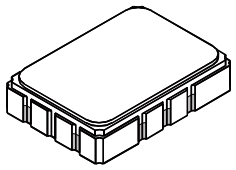
INNOVATOR IN ELECTRONICS

SF2040B-2

80.460 MHz SAW Filter

- ***Designed for SDARS IF Receiver***
- ***Low Insertion Loss***
- ***5.0 X 7.0 mm Surface-Mount Case***
- ***Differential or Single Ended Input and Output***
- ***Complies with Directive 2002/95/EC (RoHS)***



SMP-03

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range (with tape & reel)	-40 to +85	°C
Storage Temperature Range (without tape & reel)	-50 to +125	°C
Max Soldering Profile	265°C for 10 s	

Electrical Characteristics

Characteristic		Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency		f_C	1		80.460		MHz
Passband	Insertion Loss	IL			9.5	12.0	dB
	1dB Passband	BW_1	1	3.7	4.1		MHz
	15dB Bandwidth	BW_{15}			6.6	6.7	MHz
	30dB Bandwidth	BW_{30}			7.6	7.7	MHz
	Amplitude Ripple over fc ±1.85 MHz				0.5	1.10	dB_{P-P}
	Group Delay Variation over fc ±1.85 MHz	GDV			60	150	ns_{P-P}
Rejection	50 to 74.39 MHz		1, 3	40	44		dB
	74.39 to 75.99 MHz			32	40		
	85.21 to 86.5 MHz			35	44		
	86.5 to 91.50 MHz			37	48		
	91.50 to 100 MHz			45	53		
Operating Temperature Range		T_A	1	-40		+105	°C
Frequency Temperature Coefficient		FTC			-18		ppm/°C
Differential Input		175 ohms					
Differential Output		1000 ohms					
Case Style			6	SMP-03 7 x 5 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift) See note 4				RFM SF2040B-2 YYWWS			

Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others

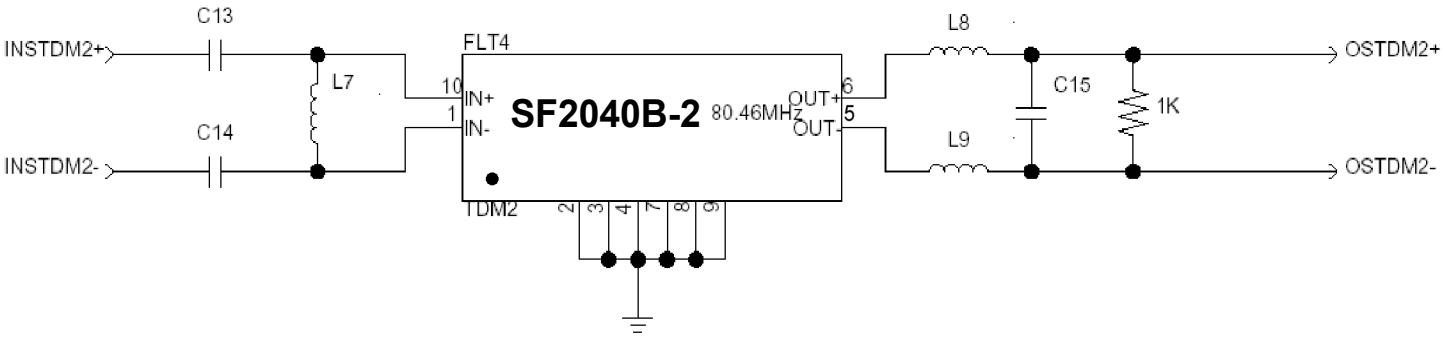
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

Matching Circuit and Matching Component Values Used in G3 Sirius Radios

(Refer to Sirius Radio G3 Chipset Application Note, Doc. #RX000104-B, Sec. 4.2.5)

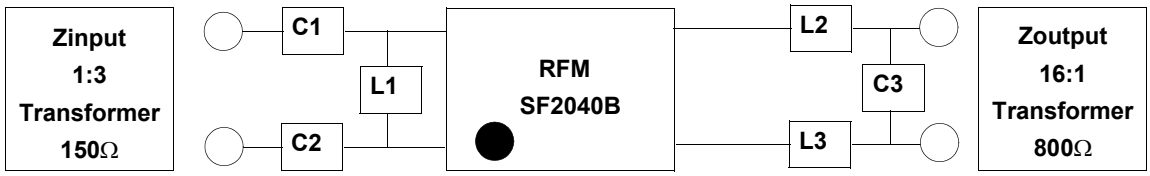


TDM2 Narrowband SAW Matching Circuit

TDM2 Narrowband SAW Matching Values

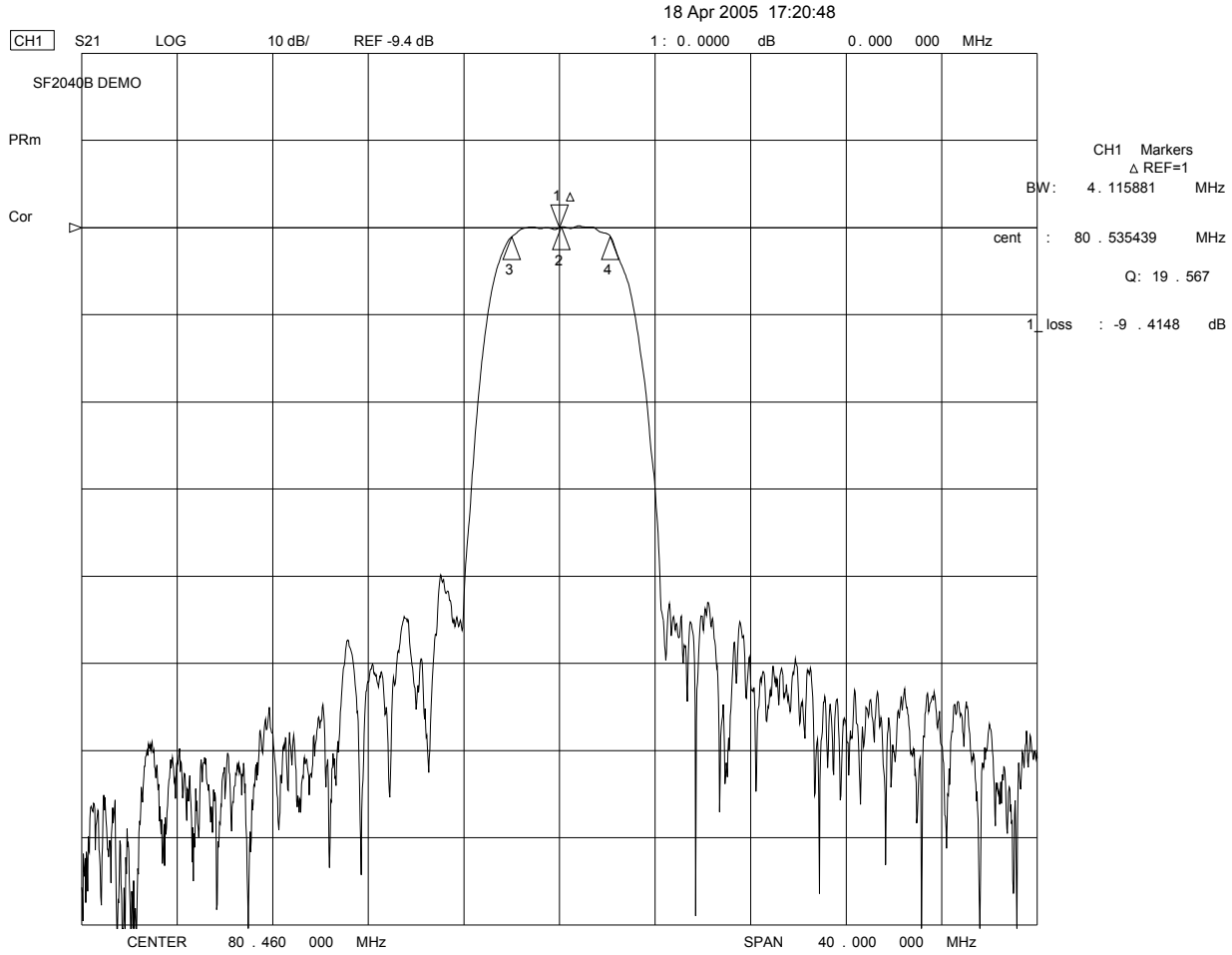
Reference Designator	Value
C13	12 pF
C14	12 pF
L7	240 nH
L8	390 nH
L9	390 pF
C15	10 pF

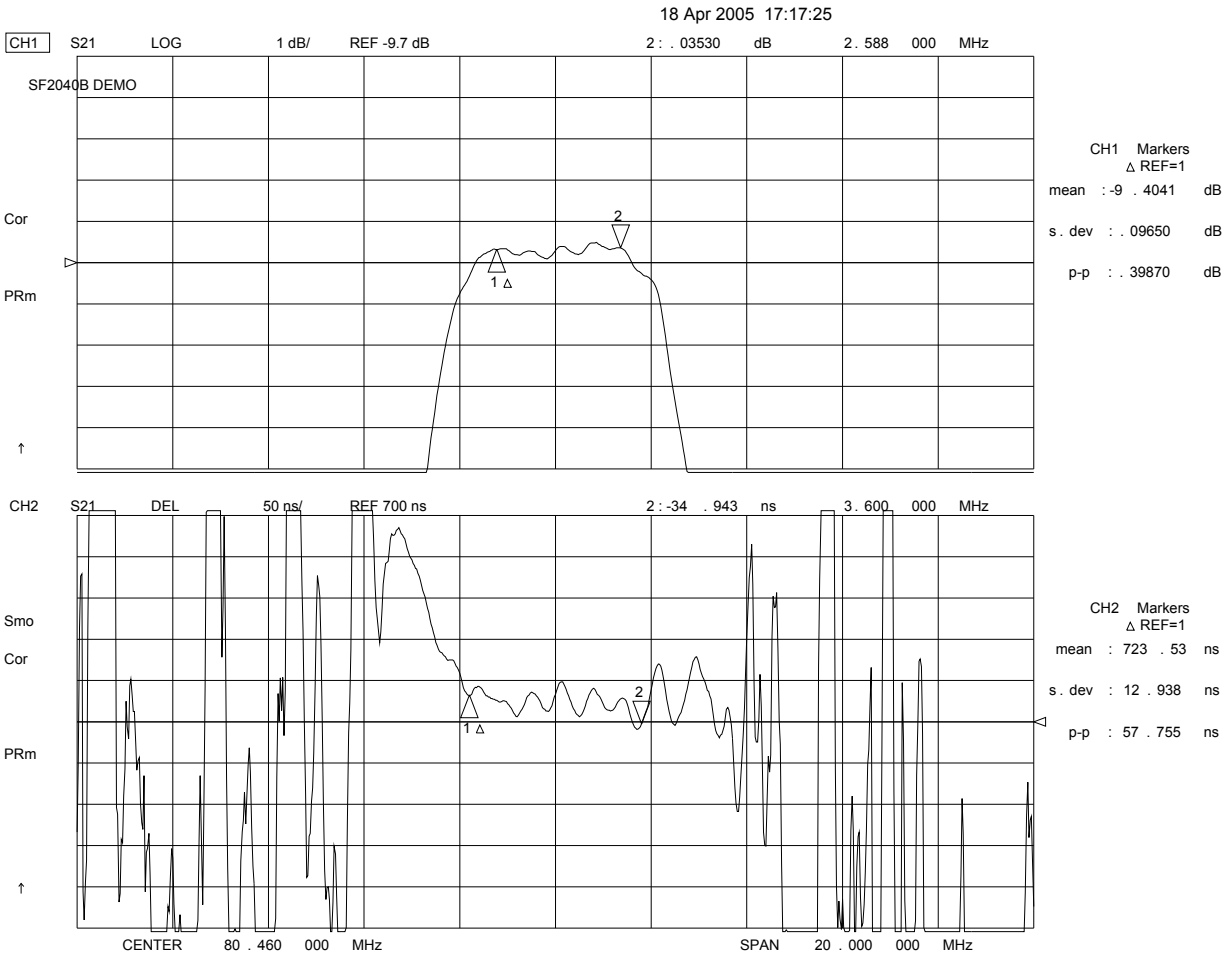
Matching Circuit and Matching Component Values Used on Filter Demo Board

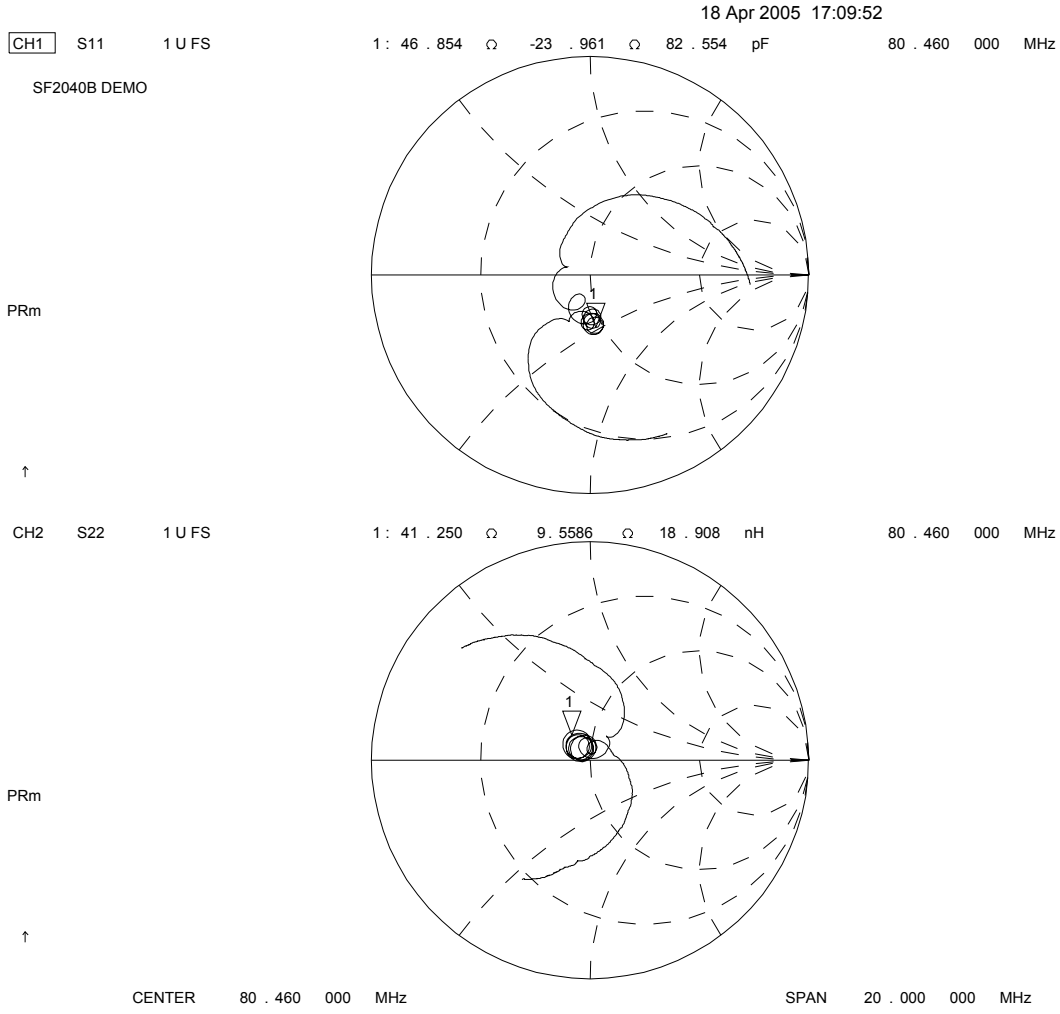


SF2040B
80.460 MHz

C1 = 9pF
C2 = 9pF
L1 = 270nH
L2 = 330nH
L3 = 330pF
C3 = 12pF



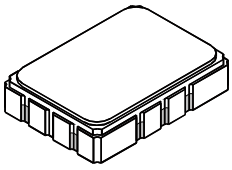




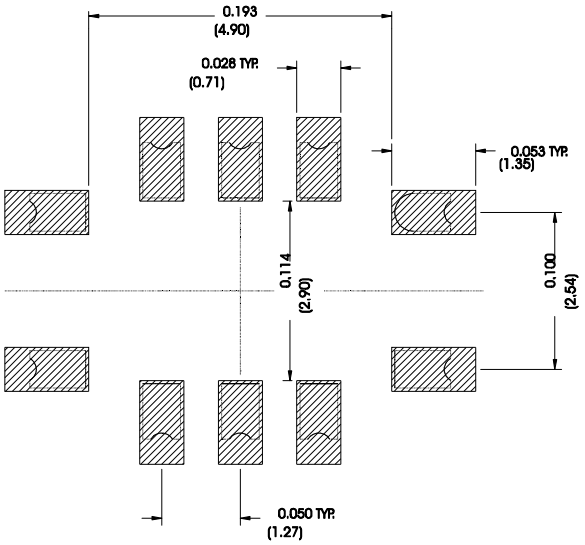
SMP-03 Case

10-Terminal Ceramic Surface-Mount Case

7 x 5 mm Nominal Footprint



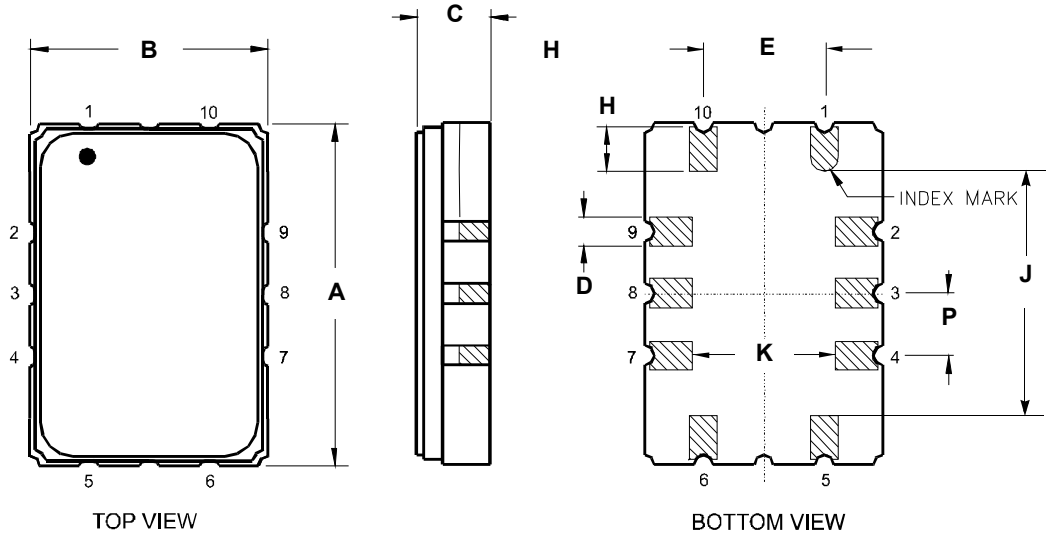
Recommended PCB Footprint



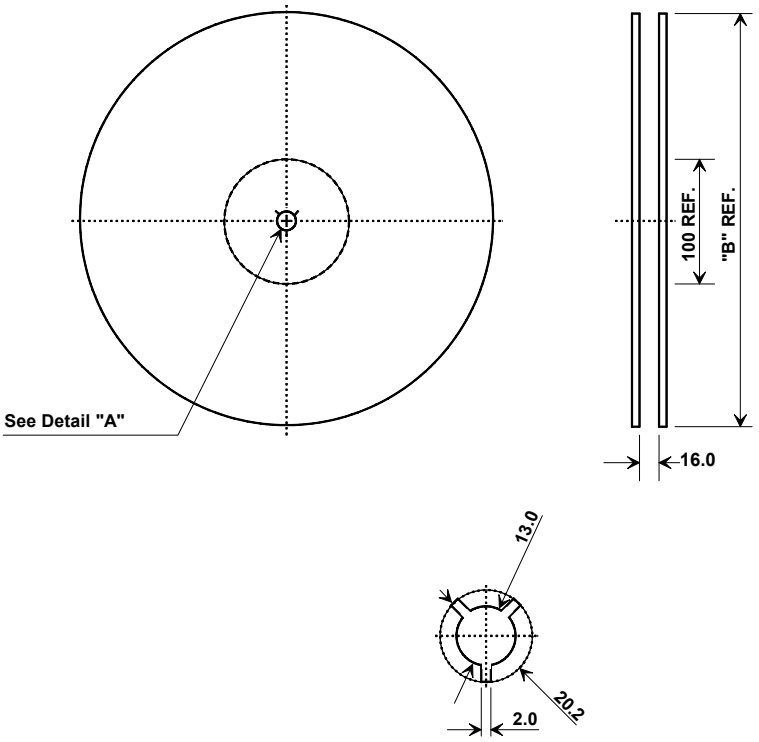
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

Materials	
Solder Pad Termination	Au plating 30 - 60 uInches (76.2-152 uM) over 80-200 uInches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 uInches Thick
Body	Al_2O_3 Ceramic
Pb Free	

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		**Return is ground**
Differential Operation		**Return is hot**



Tape and Reel Specifications



"B "		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm